

Product Specification

Product Name: Multi-protocol Cloud Module

Model Name: DSM-04D

Revision History

Specification		Sect.	Sect. Update Description	
Rev	Date			
1.0	2022-11-2		New version release	Li

Approvals

Organization	Name	Title	Date

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1 Introduction

1.1 Purpose& Description

DSM-04D is a low power-consuming embedded Zigbee/matter/BLE module developed By Dusun. It consists of the highly integrated wireless radio processor chip, EFR32MG24A020F1536IM40-B, and several peripherals, with a built-in 802.15.4 PHY/MAC Zigbee/matter/BLE network protocol stack and robust library functions.

This data terminal device is embedded with a low power-consuming 32-bit ARM Cortex-M33 core, 1024/1536 KB flash memory, 256 KB RAM data memory, and robust peripheral resources. Besides, it runs on the Free RTOS platform that integrates all Zigbee/matter/BLE MAC library functions. You can develop built-in Zigbee/matter/BLE products as required.

- 1.2 Product Feature Summary
- Low Power Wireless System-on-Chip
 - ➤ High Performance 32-bit 78 MHz ARM Cortex®-M33 with DSP instruction and floating-point unit for efficient signal processing
 - > Up to 1536 kB flash program memory
 - Up to 256 kB RAM data memory
 - > 2.4 GHz radio operation
 - Matrix Vector Processor for AI/ML acceleration
- Radio Performance
 - -105.4 dBm sensitivity @ 250 kbps O-QPSK DSSS
 - -105.7 dBm sensitivity @ 125 kbps GFSK
 - > -97.6 dBm sensitivity @ 1 Mbps GFSK
 - -94.8 dBm sensitivity @ 2 Mbps GFSK
 - > TX power up to 19.5 dBm
- Working voltage: 2.0 V to 3.8 V
- Working temperature: –40°C to +85°C
- Low System Energy Consumption
 - > 4.4 mA RX current (1 Mbps GFSK)
 - 5.1 mA RX current (250 kbps O-QPSK DSSS)
 - 5 mA TX current @ 0 dBm output power
 - > 19.1 mA TX current @ 10 dBm output power
 - > 156.8 mA TX current @ 19.5 dBm output power
 - 33.4 μA/MHz in Active Mode (EM0) at 39.0 MHz
 - > 1.3 μA EM2 Deep Sleep current (16 kB RAM retention and RTC running from LFRCO)
- Protocol Support
 - Matter
 - Open Thread
 - Zigbee
 - ➤ Bluetooth Low Energy (BLE 5.3)
 - Bluetooth Mesh
 - Proprietary 2.4 GHz
 - Multiprotocol
- Dimension: 17 x 22 x 2.8 mm

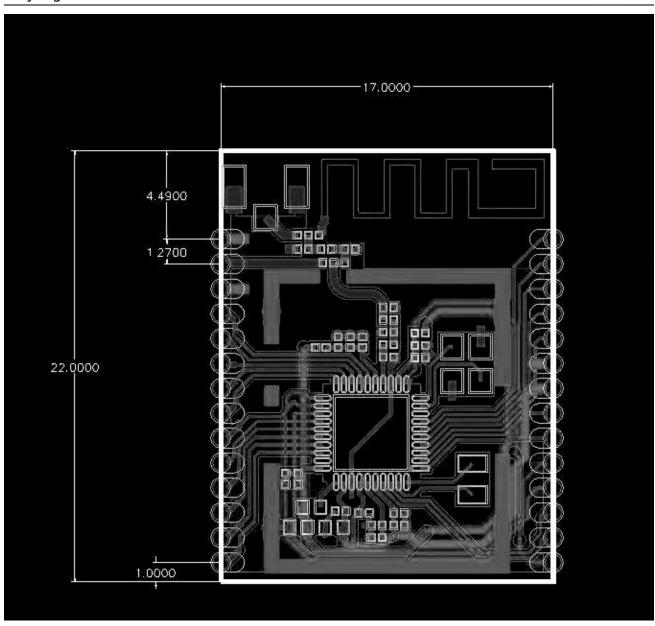


- Certification CE, FCC, SRRC
 - Scenario 1.3
- Intelligent Building
- Intelligent Home And Household Applications
- Intelligent Socket And Smart Lighting
- **Industrial Wireless Control**
- **Baby Monitor**
- IP Camera
- Intelligent Public Traffic
- 2 Mechanical Requirement
 - 2.1 Drawing

2.2 **Dimensions**

DSM-04D provides two rows of pins(2 *14) with the pin pitch of 1.27±0.1mm Dimensions: 17±0.35 mm (W) x 22±0.35 mm (L) x 2.8±0.15 mm (H).





2.3 Pin Definition

2.3	Pin Definition		
Pin Number	Symbol	Ю	Function
		Туре	
1	GND	Р	Power supply reference ground pin
2	ANT	RF	RF signal input/output port, which corresponds to ANT of IC
3	GND	Р	Power supply reference ground pin
4	PB04	I/O	Corresponding to PB04 of IC
5	PB03	I/O	Corresponding toPB03 of IC

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6	PB02	I/O	Corresponding to PB02 of IC
7	PB01	I/O	Corresponding to PB01 of IC
8	PB00	I/O	Corresponding to PB00 of IC
9	PA00	I/O	Corresponding to PA00 of IC
10	PA03	I/O	Corresponding to PA03 of IC
11	PA04	I/O	Corresponding to PA04 of IC
12	PA05	I/O	Corresponding to PA05 of IC
13	PA06	I/O	Corresponding to PA06 of IC
14	PA07	I/O	Corresponding to PA07 of IC
15	RESET	1	Corresponding to reset of IC
16	PD03	I/O	Corresponding to PD03 of IC
17	PD02	I/O	Corresponding to PD02 of IC
18	SWCLK	I/O	Corresponding to SWCLKof IC
19	SWDIO	I/O	Corresponding to SWDIO of IC
20	PC00	I/O	Corresponding to PC00 of IC
21	PC01	I/O	Corresponding toPC01of IC
22	VCC	Р	Power supply pin (3.3V)
23	GND	Р	Power supply reference ground pin
24	PC02	I/O	Corresponding to PC02 of IC
25	PC03	I/O	Corresponding to PC03of IC
26	PC04	I/O	Corresponding to PC04 of IC
27	PC05	I/O	Corresponding toPC05of IC
28	PC06	I/O	Corresponding toPC06of IC
	•	1	

[•] P indicates power supply pins, I/O indicates input/output pins, and AI indicates analog input pins.

3 Electrical parameters

3.1 Absolute electrical parameters

Parameter	Description	Min.	Max.	Unit
Ts	Storage temperature	-40	85	$^{\circ}$
VCC	Power supply voltage	2.0	3.8	V



Static electricity voltage (human body	TAMB-25℃	-	2	KV
model)				
Static electricity voltage (machine	TAMB-25℃	-	0.5	KV
model)				

3.2 Working conditions

Parameter	Description	Min.	Тур.	Max.	Unit
Та	Working temperature	-40	-85	-	\mathbb{C}
VCC	Power supply voltage	2.0	3.0	3.8	V
VIL	I/O low-level input	-	I0VDD*0.3		V
VIH	I/O high-level input	I0VDD*0.7	-	-	V
VOL	I/O low-level output	-	I0VDD*0.2	-	V
VOH	I/O high-level output	I0VDD*0.8	-	-	V

3.3 Radio current consumption at 3.0V

Working status	TX Power/ Receiving	Тур.	Max.	Unit
I _{TX}	f=2.4GHz, CW, 0dBm PA, 0dBm output power, VSCALE2	6	-	mA
	f=2.4GHz, CW, 10dBm PA, 10dBm output power, VSCALE2	20	-	mA
	f=2.4GHz, CW, 20dBm PA,19.5dBm output power,VSCALE2, VREGVDD = PAVDD= 3.3 V	158	-	mA
	125 kbit/s, 2GFSK, f = 2.4 GHz,VSCALE2	5.5	-	mA
	500 kbit/s, 2GFSK, f = 2.4 GHz,VSCALE2	5.5	-	mA
I _{RX}	1 Mbit/s, 2GFSK, f = 2.4 GHz,VSCALE2	5	-	mA
	2 Mbit/s, 2GFSK, f = 2.4 GHz,VSCALE2	6	-	mA
	802.15.4 receiving frame, f = 2.4GHz, VSCALE2	6	-	mA

3.4 MCU current consumption at 3.0 V

Working mode	Working status (Ta = 25° C)	Average	Max.	Unit
Current consumption in	78 MHz HFRCO w/ DPLL referenced to 39 MHz crystal,	34	-	uA/MHz
EM0mode with all	CPU running Core Mark loop from flash,VSCALE2			
peripherals dis-abled				
Current consumption in	78 MHz HFRCO w/ DPLL referenced to 39 MHz	23	-	uA/MHz
EM1mode with all	crystal,VSCALE2			
peripherals dis-abled				
Current consumption in	256 kB RAM and full Radio RAM retention, RTC running	3	-	uA/MHz
EM2mode, VSCALE0	fromLFXO ¹			
Current consumption in	256 kB RAM and full Radio RAM retention, RTC running	3	-	mA
EM3mode, VSCALE0	fromULFRCO ¹			

Note:



1. CPU cache retained, EM0/1 peripheral states retained

4 RF features

4.1 Basic RF feature

Parameter	Description
Frequency band	2.412~2.484GHz
Protocol standard	Zigbee 3.0/BLE 5.3/Matter/ Open Thread/ Proprietary 2.4 GHz
Antenna type	PCB antenna with a gain of 0.5dBi. IPEX (optional)

4.2 RF Transmitter Characteristics

4.2.1 RF Transmitter General Characteristics for the 2.4 GHz Band

Parameter	Test Condition	Min.	Тур.	Max.	Unit
RF tuning frequency range		2400	-	2483.5	MHz
Max. output power ²	20 dBm PA, PAVDD = 3.3 V	-	19.5	-	dBm
Min. output power	20 dBm PA, PAVDD = 3.3 V	-	-34	-	dBm
Output power variation vs	20 dBm PA Pout = POUTMAX out-put power				
supply voltage variation,	with PAVDD voltage swept from 3.0 V to 3.8	_	0.75	-	dB
frequency=2450MHz	V				
Output power variation vs	PAVDD = 3.3 V supply, 20 dBm PA at				
temperature, Frequency=2450	POUTMAX, (-40 to +125 °C)	-	0.7	-	dB
MHz					
Output power variation vs RF	20 dBm PA, POUTMAX, PAVDD =3.3 V		0.17	_	dB
frequency		_	0.17	-	ав
Spurious emissions of	Continuous transmission of CW carrier,				
harmonics in restricted bands	Pout=POUTMAX, Test Frequency=2450MHz.	-	-47	-	dBm
per FCC Part 15.205/15.209					
Spurious emissions of	Continuous transmission of CW carrier. Pout =				
harmonics in non-restricted	POUTMAX. Test Frequency = 2450 MHz		-26		dBc
bands per FCC		_	-20	-	abc
Part15.247/15.35					
	Restricted bands 30-88MHz,Continuous				
	transmission of CW carrier, Pout=POUTMAX,	-	-61	-	dBm
	Test Frequency = 2450 MHz				
	Restricted bands 88-216MHz,Continuous				
Spurious emissions out-of-band	transmission of CW carrier, Pout = POUTMAX,	-	-58	-	dBm
(above 2.483 GHz or below 2.4	Test Frequency = 2450 MHz				
GHz) in restricted bands, per	Restricted bands 216-960MHz,Continuous				
FCC part15.205/15.209	transmission of CW carrier, Pout = POUTMAX,	-	-55	-	dBm
	Test Frequency = 2450 MHz				
	Restricted bands>960MHz,				
	Continuous transmission of CW carrier, Pout=	_	-47	-	dBm
	POUTMAX, Test Frequency = 2450 MHz				



Frequencies above 2.483GHz or below				
2.4GHz,continuous transmission CW carrier,	-	-26	-	dBm
Pout=POUTMAX, Test Frequency=2450 MHz				
47-74 MHz,87.5-108 MHz,174-230 MHz,				
470-862 MHz, Pout= 10 dBm, Test Frequency	-	-60	_	dBm
= 2450MHz				
25-1000 MHz, excluding above frequencies.		40		ID.
Pout = 10 dBm, Test Frequency = 2450 MHz	-	-42	_	dBm
1G-14G, Pout = 10 dBm, Test Frequency =		26		
2450 MHz	-	-36	-	dBm
[2400-2BW to 2400-BW],[2483.5+BW to				
2483.5+2BW],Pout = 10 dBm, Test Frequency	-	-26	-	dBm
=2450 MHz				
47-74 MHz, 87.5-118 MHz,174-230 MHz,				
470-862 MHz, Pout= 10 dBm, Test Frequency	-	-60	_	dBm
= 2450MHz				
30-47 MHz, 74-87.5 MHz,118-174 MHz,				
230-470MHz,862-1000 MHz ,	_	-42	_	dBm
Pout=10dBm,Test Frequency=2450 MHz				
1G-12.75 GHz, excluding bands listed above,		26		-ID
Pout=10dBm, Test Frequency = 2450 MHz	_	-36	_	dBm
[2400-BW to 2400], [2483.5 to2483.5+BW]		1.0		d Duo
Pout=10dBm, Test Frequency=2450 MHz	_	- 16	_	dBm
	-15	-	15	ppm
	2.4GHz,continuous transmission CW carrier, Pout=POUTMAX, Test Frequency=2450 MHz 47-74 MHz,87.5-108 MHz,174-230 MHz, 470-862 MHz, Pout= 10 dBm, Test Frequency = 2450MHz 25-1000 MHz, excluding above frequencies. Pout = 10 dBm, Test Frequency = 2450 MHz 1G-14G, Pout = 10 dBm, Test Frequency = 2450 MHz [2400-2BW to 2400-BW],[2483.5+BW to 2483.5+2BW],Pout = 10 dBm, Test Frequency = 2450 MHz 47-74 MHz, 87.5-118 MHz,174-230 MHz, 470-862 MHz, Pout= 10 dBm, Test Frequency = 2450MHz 30-47 MHz, 74-87.5 MHz,118-174 MHz, 230-470MHz,862-1000 MHz, Pout=10dBm,Test Frequency=2450 MHz 1G-12.75 GHz, excluding bands listed above, Pout=10dBm, Test Frequency = 2450 MHz [2400-BW to 2400], [2483.5 to2483.5+BW]	2.4GHz,continuous transmission CW carrier, Pout=POUTMAX, Test Frequency=2450 MHz 47-74 MHz,87.5-108 MHz,174-230 MHz, 470-862 MHz, Pout= 10 dBm, Test Frequency = 2450MHz 25-1000 MHz, excluding above frequencies. Pout = 10 dBm, Test Frequency = 2450 MHz 1G-14G, Pout = 10 dBm, Test Frequency = 2450 MHz [2400-2BW to 2400-BW],[2483.5+BW to 2483.5+2BW],Pout = 10 dBm, Test Frequency = 2450 MHz 47-74 MHz, 87.5-118 MHz,174-230 MHz, 470-862 MHz, Pout= 10 dBm, Test Frequency = 2450MHz 30-47 MHz, 74-87.5 MHz,118-174 MHz, 230-470MHz,862-1000 MHz, Pout=10dBm, Test Frequency=2450 MHz 1G-12.75 GHz, excluding bands listed above, Pout=10dBm, Test Frequency = 2450 MHz [2400-BW to 2400], [2483.5 to 2483.5+BW] Pout=10dBm, Test Frequency=2450 MHz	2.4GHz,continuous transmission CW carrier, Pout=POUTMAX, Test Frequency=2450 MHz 47-74 MHz,87.5-108 MHz,174-230 MHz, 470-862 MHz, Pout= 10 dBm, Test Frequency = 2450MHz 25-1000 MHz, excluding above frequencies. Pout = 10 dBm, Test Frequency = 2450 MHz 1G-14G, Pout = 10 dBm, Test Frequency = 2450 MHz [2400-2BW to 2400-BW],[2483.5+BW to 2483.5+2BW],Pout = 10 dBm, Test Frequency26 =2450 MHz 47-74 MHz, 87.5-118 MHz,174-230 MHz, 470-862 MHz, Pout= 10 dBm, Test Frequency60 = 2450MHz 30-47 MHz, 74-87.5 MHz,118-174 MHz, 230-470MHz,862-1000 MHz, Pout=10dBm,Test Frequency=2450 MHz 1G-12.75 GHz, excluding bands listed above, Pout=10dBm, Test Frequency = 2450 MHz [2400-BW to 2400], [2483.5 to2483.5+BW] Pout=10dBm, Test Frequency=2450 MHz	2.4GHz,continuous transmission CW carrier, Pout=POUTMAX, Test Frequency=2450 MHz 47-74 MHz,87.5-108 MHz,174-230 MHz, 470-862 MHz, Pout= 10 dBm, Test Frequency = 2450MHz 25-1000 MHz, excluding above frequencies. Pout = 10 dBm, Test Frequency = 2450 MHz 1G-14G, Pout = 10 dBm, Test Frequency = 2450 MHz [2400-2BW to 2400-BW],[2483.5+BW to 2483.5+2BW], Pout = 10 dBm, Test Frequency = -2450 MHz 47-74 MHz, 87.5-118 MHz,174-230 MHz, 470-862 MHz, Pout= 10 dBm, Test Frequency = -6060 = 2450MHz 30-47 MHz, 74-87.5 MHz,118-174 MHz, 230-470MHz,862-1000 MHz, Pout=10dBm, Test Frequency = -42 -

Note:

- 1. Supply current to radio, supplied by DC-DC with 3.0 V, measured at VREGVDD.
- 2. Supported transmit power levels are determined by the ordering part number (OPN). Transmit power ratings for all devices covered in this data sheet can be found in the Max TX Power column of the Ordering Information Table.
- 3. The PA is capable of delivering higher than 10 dBm output power (refer to Output Power plots in 4.27.2 RF Characteristics). How-ever, all transmitter characteristics and recommended application circuits are specified at 10 dBm output. If used with the recommended application circuits above 10 dBm, harmonics may be higher than regulatory limits.

4.2.2 RF Transmitter Characteristics for 802.15.4 DSSS-OQPSK in the 2.4 GHz Band

Parameter	Test Condition	Min.	Тур.	Max.	Unit	
Error voeter magnitude	Average across frequency, signal is					
Error vector magnitude per802.15.4-2011(EVM)	DSSS-OQPSK reference pack-et,	-	-3	-	% rms	
	PAVDD=3.3 V, Pout=POUTMAX					
Dower enestral density limit	Relative, at carrier ±3.5MHz,PAVDD=3.3V,		50.0		dBc/100k	
Power spectral density limit	Pout=POUT _{MAX}	-	-50.2	-	Hz	
Occupied channel bandwidth	99% BW at highest and lowest channels in				N 41 1-	
per ETSI EN300.328	band, Pout=10dBm	-	2.2	-	MHz	



Note:

1.Per Bluetooth Core_5.1, Vol.6 Part A, Section 3.2.2, exceptions are allowed in up to three bands of 1 MHz width, centered on a frequency which is an integer multiple of 1 MHz. These exceptions shall have an absolute value of -20 dBm or less

4.2.3 RF Transmitter Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 1 Mbps Data Rate

Parameter	Test Condition	Min.	Тур.	Max.	Unit
Transmit 6 dB bandwidth	PAVDD=3.3 V, P _{out} =POUT _{MAX}	-	-718	-	KHz
Power spectral density limit	PAVDD=3.3 V, P _{out} =POUT _{MAX} , Per FCC part	_	-0.5	-	dBm/3kHz
	15.24				
Occupied channel bandwidth	P _{out} =10dBm 99% BW at highestand lowest	_	1		MHz
per ETSI EN300.328	channels in band	_	ı	_	IVITIZ
In-band spurious emissions,	PAVDD=3.3V, P _{out} =POUT _{MAX} , Inband spurs at		-26		dBm
with allowed exceptions1	± 2 MHz	_	-20	-	UDIII

Note:

1.Per Bluetooth Core_5.1, Vol.6 Part A, Section 3.2.2, exceptions are allowed in up to three bands of 1 MHz width, centered on afrequency which is an integer multiple of 1 MHz. These exceptions shall have an absolute value of -20 dBm or less

4.2.4 RF Transmitter Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 2 Mbps Data Rate

Parameter	Test Condition	Min.	Тур.	Max.	Unit
Transmit 6 dB bandwidth	PAVDD=3.3V, P _{out} =POUT _{MAX}	-	-1307	-	KHz
Power spectral density limit	PAVDD=3.3V, P _{out} =POUT _{MAX} , Per FCC part 15.24	-	-1.5	-	dBm/3kHz
Occupied channel bandwidth per ETSI EN300.328	P _{out} =10dBm 99% BW at highestand lowest channels in band	-	2.1	-	MHz
In-band spurious emissions, with allowed exceptions1	PAVDD=3.3 V, P _{out} =POUT _{MAX} , Inband spurs at ± 2 MHz	-	-33	-	dBm

Note:

1.Per Bluetooth Core_5.1, Vol.6 Part A, Section 3.2.2, exceptions are allowed in up to three bands of 1 MHz width, centered on a frequency which is an integer multiple of 1 MHz. These exceptions shall have an absolute value of -20 dBm or less

4.2.5 RF Transmitter Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 500 kbps Data Rate

Parameter	Test Condition	Min.	Тур.	Max.	Unit
Transmit 6 dB bandwidth	PAVDD=3.3 V, P _{out} =POUT _{MAX}	-	-717	-	KHz
Device an estual demaits limit	PAVDD=3.3 V, Pout=POUTMAX, Per FCC part		0.5		-ID /OI-II-
Power spectral density limit	15.24	-	-0.5	_	dBm/3kHz
Occupied channel bandwidth	P _{out} =10dBm 99% BW at highestand lowest				NALL-
per ETSI EN300.328	channels in band	-		_	MHz
In-band spurious emissions,	PAVDD=3.3 V, P _{out} =POUT _{MAX} , Inband spurs	-	-26	-	dBm



with allowed exceptions1	at ± 2 MHz		

Note:

1.Per Bluetooth Core_5.1, Vol.6 Part A, Section 3.2.2, exceptions are allowed in up to three bands of 1 MHz width, centered on a frequency which is an integer multiple of 1 MHz. These exceptions shall have an absolute value of -20 dBm or less

4.2.6 RF Transmitter Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 125 kbps Data Rate

Parameter	Test Condition	Min.	Тур.	Max.	Unit	
Transmit 6 dB bandwidth	PAVDD=3.3 V, Pout=POUT _{MAX}	-	-651	-	KHz	
Power spectral density limit	PAVDD=3.3 V, Pout=POUT _{MAX} , Per FCC		-14		dBm/3kHz	
	part 15.24	-		-		
Occupied channel bandwidth	P _{out} =10dBm 99% BW at highestand lowest		1		NALI-	
per ETSI EN300.328	channels in band	-	'	-	MHz	
In-band spurious emissions,	PAVDD=3.3 V, P _{out} =POUT _{MAX} , Inband spurs		200		dD:se	
with allowed exceptions1	at ± 2 MHz	-	-26	-	dBm	

Note:

1.Per Bluetooth Core_5.1, Vol.6 Part A, Section 3.2.2, exceptions are allowed in up to three bands of 1 MHz width, centered on a frequency which is an integer multiple of 1 MHz. These exceptions shall have an absolute value of -20 dBm or less

4.3 RF Receiver Characteristics

4.3.1 RF Receiver General Characteristics for the 2.4 GHz Band

Parameter	Test Condition	Min.	Тур.	Max.	Unit
RF tuning frequency range		2400	-	2483.5	MHz
Receive mode Max. spurious	30 MHz to 1 GHz	-	-63	-	dBm
emission	1 GHz to 12 GHz	-	-53	-	dBm
Max spurious emissions during active receive mode,	216 MHz to 960 MHz, conducted measurement	-	-55	-	dBm
per FCC Part 15.109(a)	Above 960 MHz, conducted measurement	-	-47	-	dBm
2050K Concitivity	2 Mbps 2GFSK signal, 1% PER	-	-92.5	-	dBm
2GFSK Sensitivity	250 kbps 2GFSK signal, 0.1%BER	-	-102.9	-	dBm
Note:			-		

Note:

1.Supply current to radio, supplied by DC-DC with 3.0 V

4.3.2 RF Receiver Characteristics for 802.15.4 DSSS-OQPSK in the 2.4 GHz Band

Parameter	Test Condition	Min.	Тур.	Max.	Unit
Max usable receiver input level, 1%	Signal is reference signal ¹ , packet		10	-	dBm
PER	length is 20 octets	-			UDIII
Sensitivity, 1% PER	Signal is reference signal, packet	-	-105	-	dBm
	length is 20 octets				
Co-channel interferer rejection, 1%	Desired signal 3 dB above	-	0.7		10
PER	sensitivity limit		-0.7	-	dB



Adjacent channel rejection, Interferer is	Interferer is reference signal at		27		10
reference signal,1% PER, desired is	+1channel spacing	-	37	-	dB
reference signal at 3 dB above	Interferer is reference signal at		37.5		dB
reference sensitivity level ²	-1channel spacing	-	37.5	_	иь
Image rejection, 1% PER, desired is	Interferer is CW in image band3				
reference signal at3 dB above		-	53.5	-	dB
reference sensitivity level2					
Blocking rejection of all other channels,	Interferer frequency < desired		55.3		dB
1% PER, desired is reference signal at	frequency -3 channel spacing	_	55.5	_	ив
3 dB above reference sensitivitylevel2,	Interferer frequency > desired		55.1		dB
interferer is reference signal	frequency +3 channel spacing	_	55.1	-	ub

Note:

- 1. Reference signal is defined as O-QPSK DSSS per 802.15.4, Frequency range = 2400-2483.5 MHz, Symbol rate = 62.5 ksymbols/s.
- 2.Reference sensitivity level is -85 dBm.
- 3.Due to low-IF frequency, there is some overlap of adjacent channel and image channel bands. Adjacent channel CW blocker tests place the Interferer center frequency at the Desired frequency \pm 5 MHz on the channel raster, whereas the image rejection test places the CW interferer near the image frequency of the Desired signal carrier, regardless of the channel raster.

4.3.3 RF Receiver Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 1 Mbps Data Rate

Parameter	Test Condition	Min.	Тур.	Max.	Unit
Max usable receiver input level	Signal is reference signal ¹	-	10	-	dBm
Sensitivity	Signal is reference signal, 37 bytepayload ²	-	-95	-	dBm
Signal to co-channel interferer	(see notes)14	-	8.7	-	dB
N ± 1 Adjacent channel	Interferer is reference signal at +1MHz offset1546	-	-5.4	-	dB
selectivity	Interferer is reference signal at -1MHz offset1546	-	-5.3	-	dB
Selectivity to image frequency	Interferer is reference signal at image frequency with 1 MHz preci-sion ¹⁶	-	-23.3	-	dB
Intermodulation performance	n = 3 (see note ⁷)	-	-17.3	-	dBm

Note:

- 1.0.017% Bit Error Rate.
- 2.0.1% Bit Error Rate.
- 3. With non-ideal signals as specified in Bluetooth Test Specification RF-PHY.TS.5.0.1 section 4.7.1
- 4.Desired signal -67 dBm.
- 5.Desired frequency 2402 MHz ≤ Fc ≤ 2480 MHz.
- 6. With allowed exceptions.
- 7.As specified in Bluetooth Core specification version 5.1, Vol 6, Part A, Section 4.4

4.3.4 RF Receiver Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 2 Mbps

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Website: www.dusuniot www.dusunremotes.com

Floor 8, Building A, Wantong Center Hangzhou, China www.dusunlock.com



Max usable receiver input level	Signal is reference signal ¹		10	-	dBm
Sensitivity	Signal is reference signal, 37 bytepayload ²		-93	-	dBm
Signal to co-channel interferer	(see notes)14		8.6	-	dB
N ± 1 Adjacent channel Interferer is reference signal at +1MHz offset ¹⁵⁴⁶			-5.3		dB
selectivity	Interferer is reference signal at -1MHz offset1546		-5.8		dB
Selectivity to image frequency	Interferer is reference signal at image frequency with 1 MHz preci-sion ¹⁶	-	-22.8	-	dB
Intermodulation performance	n = 3 (see note ⁷)	-	-18.3	-	dBm

Note:

- 1.0.017% Bit Error Rate.
- 2.0.1% Bit Error Rate.
- 3.With non-ideal signals as specified in Bluetooth Test Specification RF-PHY.TS.5.0.1 section 4.7.1
- 4.Desired signal -67 dBm.
- 5.Desired frequency 2402 MHz ≤ Fc ≤ 2480 MHz.
- 6. With allowed exceptions.
- 7.As specified in Bluetooth Core specification version 5.1, Vol 6, Part A, Section 4.4

4.3.5 RF Receiver Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 500 kbps

Parameter	Test Condition		Тур.	Max.	Unit
Max usable receiver input level	Signal is reference signal ¹		10	-	dBm
Sensitivity	Signal is reference signal, 37 bytepayload ²		-99	-	dBm
Signal to co-channel interferer	(see notes)14		2.7	-	dB
N ± 1 Adjacent channel	I ± 1 Adjacent channel Interferer is reference signal at +1MHz offset ¹⁵⁴⁶		-7.1	-	dB
selectivity	Interferer is reference signal at -1MHz offset1546	-	-7.4	-	dB
Calasticity to impact from the property	Interferer is reference signal at image frequency	40	40		40
Selectivity to image frequency	with 1 MHz preci-sion ¹⁶	49		-	dB

Note:

- 1.0.017% Bit Error Rate.
- 2.0.1% Bit Error Rate.
- 3. With non-ideal signals as specified in Bluetooth Test Specification RF-PHY.TS.5.0.1 section 4.7.1
- 4.Desired signal -67 dBm.
- 5.Desired frequency 2402 MHz ≤ Fc ≤ 2480 MHz.
- 6. With allowed exceptions.

4.3.6 RF Receiver Characteristics for Bluetooth Low Energy in the 2.4 GHz Band 125 kbps

Parameter	Test Condition		Тур.	Max.	Unit
Max usable receiver input level	Signal is reference signal ¹		10	-	dBm
Sensitivity	Signal is reference signal, 37 bytepayload²		-104	-	dBm
Signal to co-channel interferer	(see notes)14		0.9	-	dB
N ± 1 Adjacent channel	Interferer is reference signal at +1MHz offset1546	-	-12.4	-	dB
selectivity	Interferer is reference signal at -1MHz offset1546	-	-12.8	-	dB
Selectivity to image frequency	Interferer is reference signal at image frequency		-53	-	dB



with 1 MHz preci-sion ¹⁶	
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Note:

- 1.0.017% Bit Error Rate.
- 2.0.1% Bit Error Rate.
- 3. With non-ideal signals as specified in Bluetooth Test Specification RF-PHY.TS.5.0.1 section 4.7.1
- 4.Desired signal -67 dBm.
- 5.Desired frequency 2402 MHz ≤ Fc ≤ 2480 MHz.
- 6. With allowed exceptions.



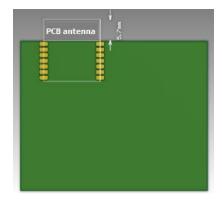
5 Antenna

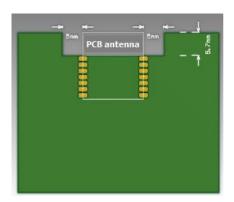
5.1 Antenna type

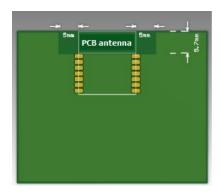
This product uses an onboard PCB antenna, whose gain is 1dBi

5.2 Antenna interference reduction

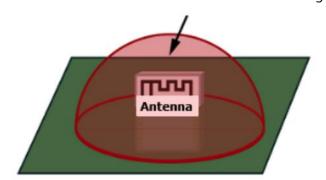
To ensure optimal RF performance, it is recommended that the antenna be at least 15 mm away from other metal parts. If metal materials are wrapped around the antenna, the wireless signals will be reduced greatly, deteriorating the RF performance.







Do not place any metal in the red area above the antenna. The recommended diameter of the circular arc is greater than 3cm.



6 Production instructions

1. Use an SMT placement machine to mount components to the stamp hole module that Dusun produces within 24 hours after the module is unpacked and the firmware is burned. If not, vacuum packs the module again. Bake the module before mounting components to the module.



- SMT placement equipment:
 - Reflow soldering machine
 - Automated optical inspection (AOI) equipment
 - Nozzle with a 6 mm to 8 mm diameter
- Baking equipment:
 - Cabinet oven
 - Anti-static heat-resistant trays
 - Anti-static heat-resistant gloves
- 2. Storage conditions for a delivered module are as follows:
- The moisture-proof bag is placed in an environment where the temperature is below 30°C and the relative humidity is lower than 70%.
- The shelf life of a dry-packaged product is six months from the date when the product is packaged and sealed.
- The package contains a humidity indicator card (HIC).



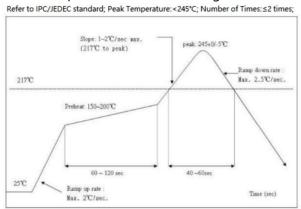
- 3. Bake a module based on HIC status as follows when you unpack the module package:
 - ◆ If the 30%, 40%, and 50% circles are blue, bake the module for 2 consecutive hours.
 - ◆ If the 30% circle is pink, bake the module for 4 consecutive hours.
 - ♦ If the 30% and 40% circles are pink, bake the module for 6 consecutive hours.
 - ◆ If the 30%, 40%, and 50% circles are pink, bake the module for 12 consecutive hours.
- 4. Baking settings:
 - ◆ Baking temperature: 125±5°C
 - ◆ Alarm temperature: 130°C
 - ◆ SMT placement ready temperature after natural cooling: < 36°C
 - Number of drying times: 1
 - ◆ Rebaking condition: The module is not soldered within 12 hours after baking.
- 5. Do not use SMT to process modules that have been unpacked for over three months.
- 6. Electroless nickel immersion gold (ENIG) is used for the PCBs. If the solder pads are exposed to the air for over three months, they will be oxidized severely and dry joints or solder skips may occur. Dusun is not liable for such problems and consequences.
- 7. Before SMT placement, take electrostatic discharge (ESD) protective measures.
- 8. To reduce the reflow defect rate, draw 10% of the products for visual inspection and AOI before first SMT placement to determine a proper oven temperature and component placement method. Draw 5 to 10 modules every hour from subsequent batches for visual inspection and AOI.



7 Recommended oven temperature curve

Perform SMT placement based on the following reflow oven temperature curve. The highest temperature is 245° C.

Based on the IPC/JEDEC standard, perform reflow soldering on a module at most twice.



8 Storage conditions



9 Ordering information



10 MOQ and packing

Product model	MOQ (pcs)	Packing method	Number of Modules in each reel pack	Number of reel packs in each box
DSM-04D	2800	Carrier tape and reel packing	700	4

FCC Statement

FCC standards: FCC CFR Title 47 Part 15 Subpart C Section 15.247

Device is equipped with PCB antenna, Antenna gain 0.5dBi

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

(1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Any Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

Note: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- -Reorient or relocate the receiving antenna.
- -Increase the separation between the equipment and receiver.
- -Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- -Consult the dealer or an experienced radio/TV technician for help.

FCC Radiation Exposure Statement

The modular can be installed or integrated in mobile or fix devices. This modular cannot be installed in any portable device if without further certification such as C2PC with SAR. This modular complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter. This modular must be installed and operated with a minimum distance of 20 cm between the radiator and user body.

If the FCC identification number is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following: "Contains Transmitter Module FCC ID: 2AWWFDSM-04D Or Contains FCC ID: 2AWWFDSM-04D"

When the module is installed inside another device, the user manual of the host must contain below warning statements;

- 1. This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:
- (1) This device may not cause harmful interference;
- (2) This device must accept any interference received, including interference that may cause undesired operation.

Note: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications.

However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- -Reorient or relocate the receiving antenna.
- -Increase the separation between the equipment and receiver.
- -Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- -Consult the dealer or an experienced radio/TV technician for help.
- 2. Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

The devices must be installed and used in strict accordance with the manufacturer's instructions as described in the user documentation that comes with the product.

Any company of the host device which install the modular with limit modular approval should perform the test of radiated & conducted emission and spurious emission, etc. according to FCC part 15C:

15.407, 15.247 and 15.209 & 15.207, 15B Class B requirement, Only if the test result comply with FCC part 15C: 15.407, 15.247 and 15.209 & 15.207, 15B Class B requirement, then the host can be sold legally.